



Product Change Notification

Change Notification #: 116737 - 01
Change Title: Intel® Server Hot-swap Backplane
A2U44X25NVMEDK2,
Intel® Server Hot-swap Backplane
A2U8X25S3HSDK,
Intel® Server Hot-swap Backplane
A2UREARHSDK,
Intel® Server Hot-swap Backplane
A2U8X25S3DPDK,
Intel® Server Hot-swap Backplane
FR1304S3HSBP,
Intel® Server Hot-swap Backplane
F2U12X35S3HSBP,
Intel® Server Hot-swap Backplane
A2U8X35S3HSDK,
Intel® Server Hot-swap Backplane
A1U44X25NVMEDK and
Intel® Server Hot-swap Backplane
F1U8X25S3HSBP,
PCN 116737-01, Product Design, Hot-Swap
Back Plane Firmware Update
Reason for Revision: Updating TA numbers
Date of Publication: June 11, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:*	February 12, 2019
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Reason for Revision: Updating TA numbers

Update Reason:

TA numbers for the products below will not change due to no update to the current FW:

- A2U44X25NVMEDK2
- F2U12X35S3HSBP
- A1U44X25NVMEDK

The TA numbers for the products below are different than TA numbers listed in PCN116737-00:

- A2U8X25S3DPDK
- FR1304S3HSBP
- F1U8X25S3HSBP

Intel is updating the Hot-Swap Back Plane (HSBP) firmware from version 1.40 to 1.41 of the Intel Server Hot-Swap Backplanes listed in the "Products Affected" table below. The firmware version 1.41 fixes a fault LED issue found on manufacturing

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre TA#	Post TA#	Pre PBA#	Post PBA#
A2U44X25NVMEDK2	947924	J11513-001	J11513-001	G97158-371	G97158-372
A2U8X25S3HSDK	935066	H47006-003	H47006-004	G97156-371	G97156-372
A2UREARHSDK	934976	H47001-002	H47001-003	G94339-371	G94339-372
A2U8X25S3DPDK	935067	H47007-004	H47007-005	G97166-272	G97166-273
FR1304S3HSBP	934887	H47018-002	H47018-003	G97162-371	G97162-372
F2U12X35S3HSBP	934893	G98599-005	G98599-005	G97164-371	G97164-372
A2U8X35S3HSDK	936191	H47008-005	H47008-006	G97160-371	G97160-372
A1U44X25NVMEDK	936251	H47009-002	H47009-002	G97154-371	G97154-372
F1U8X25S3HSBP	934888	H47019-002	H47019-003	G97152-371	G97152-372

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
January 28, 2019	00	Originally Published PCN
June 11, 2019	01	Updating TA numbers



Product Change Notification

116737 - 01

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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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